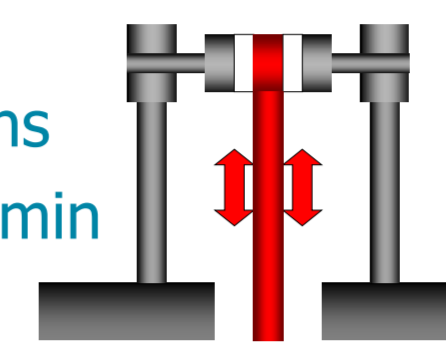


## Introduction and Objectives

- Peroxide induced cross-linking of ethylene vinyl acetate (EVA) – encapsulant during PV module lamination → **Thermo-mechanical stability of EVA**
  - Time and energy consuming, discontinuous module lamination process
- Thermo-mechanical properties of EVA films have significant influence on lamination process of PV modules → **Inadequate processing** of the EVA film can cause **severe problems during PV module lamination** like exorbitant expansion, deformation of backsheets, dislocation of cells, breakage of interconnectors and wrinkles in the module
- **Main objective: Comprehensive understanding of changes of the thermo-mechanical properties before and during PV module lamination process**
  - ➔ **Base for material related process optimization**

### Dynamic Mechanical Analysis (DMA)

- Characterization of cross-linking process
- Shear mode, Sinusoidal load at 1Hz, circular specimen
- Temperature and isotherm scans
  - Start: 25 to 225°C with 3K/min
  - 130-170°C, 10°C Interval



### Thermo-mechanical Analysis (TMA)

- Measurement of coefficient of thermal expansion (CTE) in tensile mode
- Temperature scan
  - 25 to 70°C with 2 K/min

### Materials

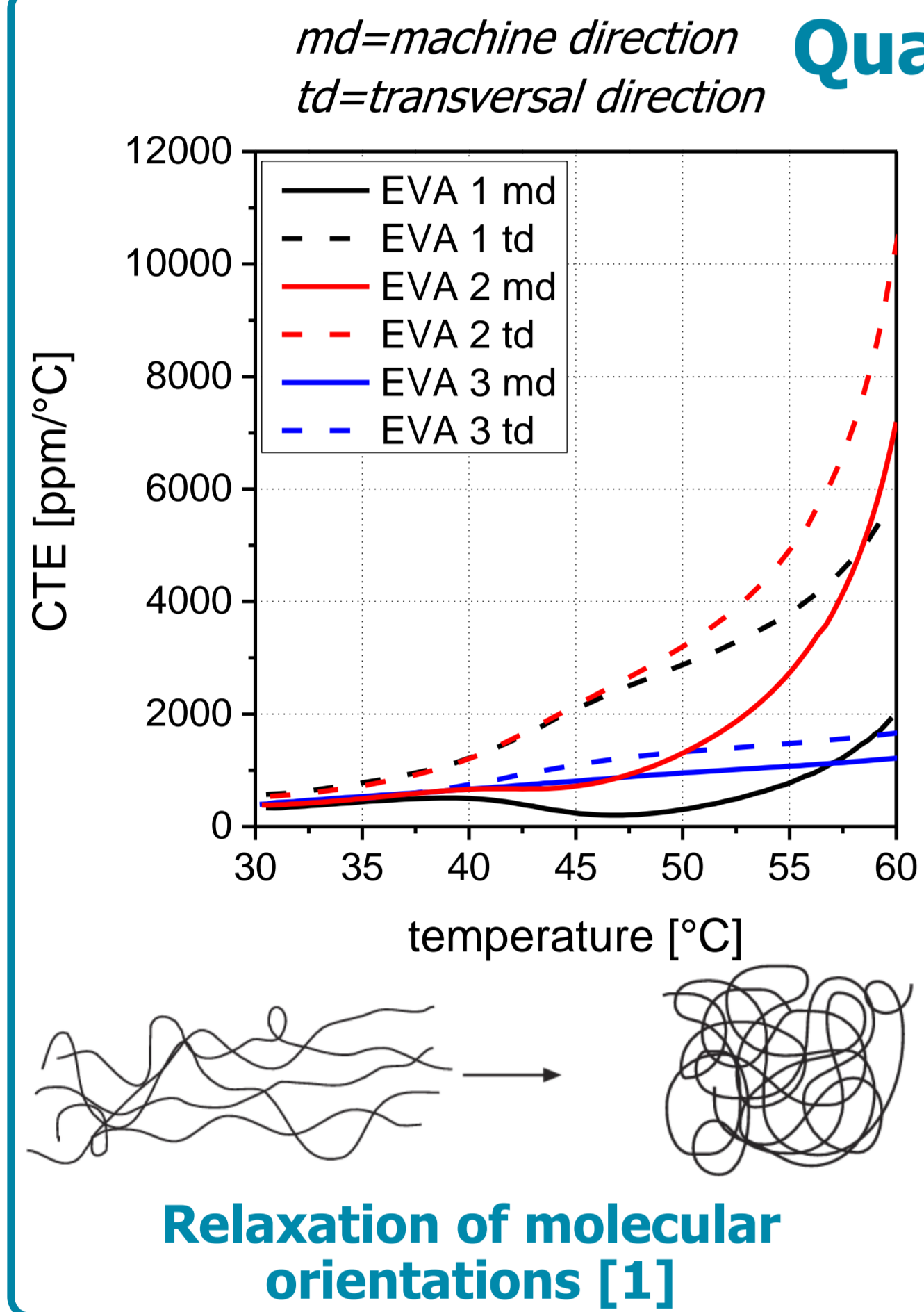
	Type	Manufacturer
EVA 1	Fast cure	A
EVA 2	Ultra-fast cure	A
EVA 3	Fast cure	B

### Production of partially cured EVA samples under relevant processing conditions

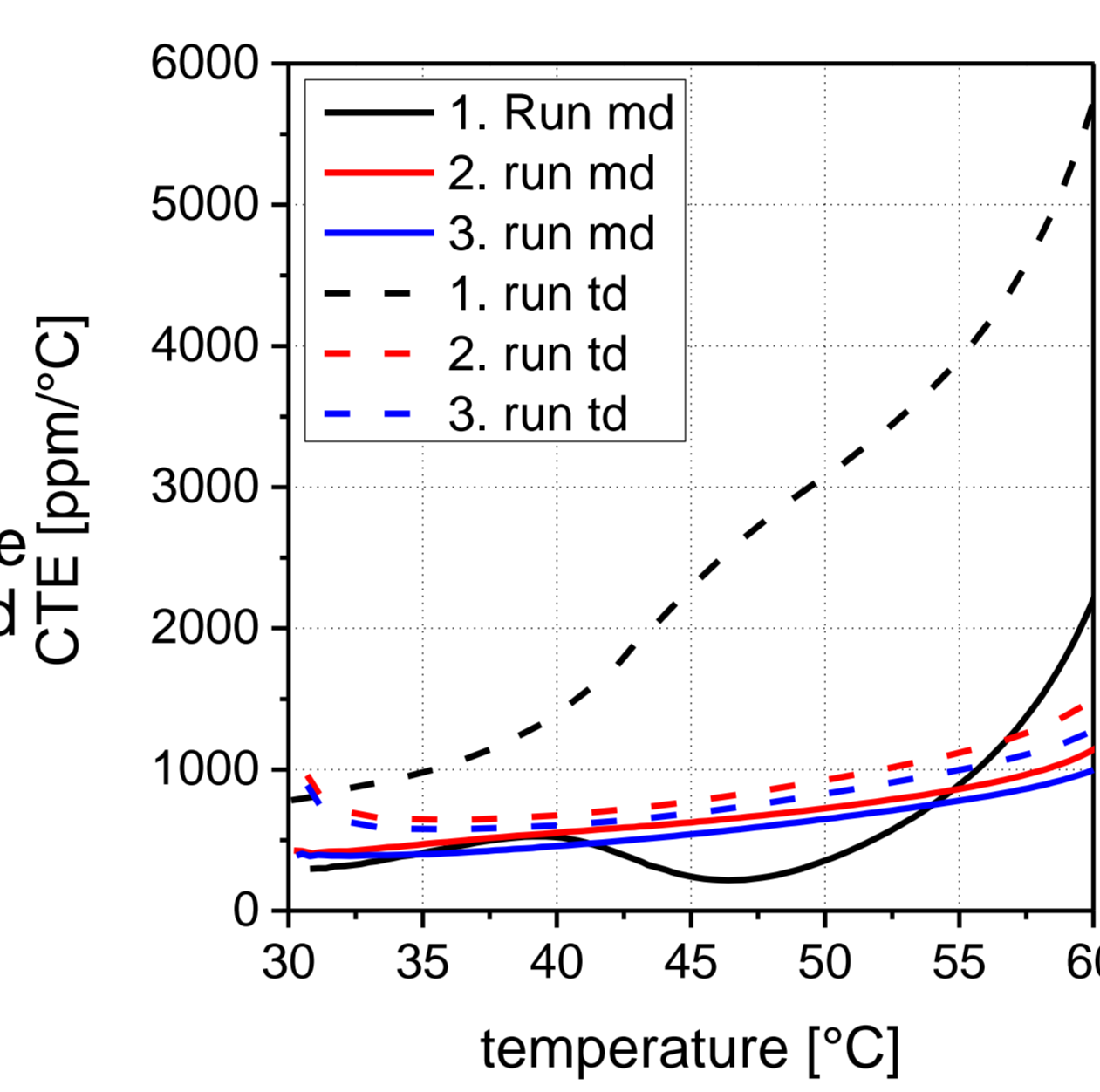
- Lamination temperature: 146°C
- Cross-linking times: 300, 360, 480, 600, 720, 1200s

## Results

### Quality control of EVA – Thermal expansion behavior during lamination



- **Increasing thermal expansion with temperature**
  - ➔ Relaxation of molecular orientations
  - ➔ Bigger expansion in td due to higher degrees of freedom
  - ➔ Shrinkage in md direction caused by melting of secondary crystals, which were formed during storage at slightly elevated temperatures (~ 40°C)
- **Strong anisotropy and enhanced thermal expansion of EVA 1+3**
  - ➔ Strong molecular orientations in md due to too fast drawing off speed during film extrusion
- **Significantly lower thermal expansion of EVA 2**
  - ➔ Less induced molecular orientations during film processing and therefore less relaxation effects



**EVA 2:**  
Sheet of 150 x 100 cm expands to 183 x 132 cm at 60°C

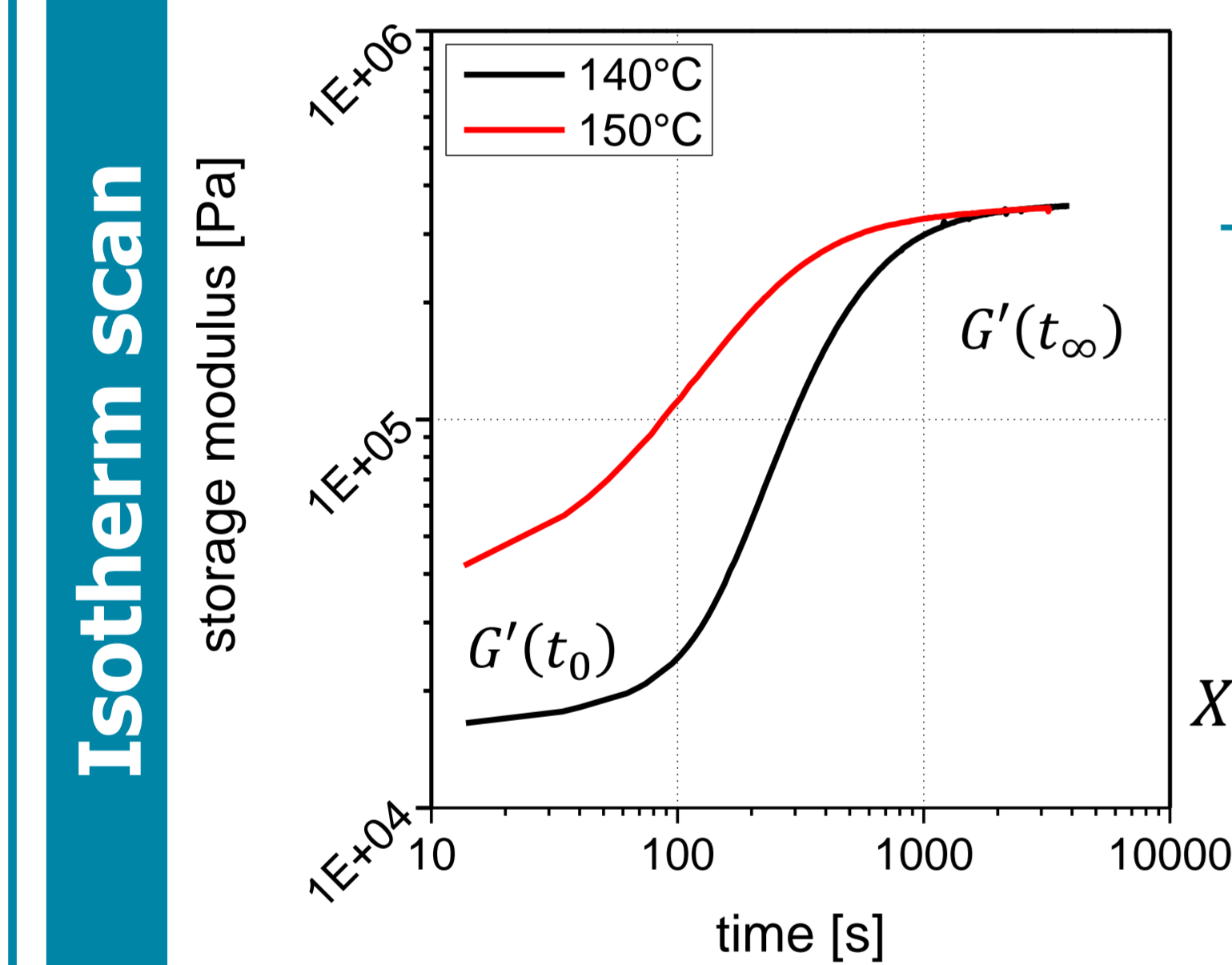
### Relaxation of orientations

- First heating run gives information on the current state of a polymer, including the thermal and mechanical history [1]
- 2<sup>nd</sup> and 3<sup>rd</sup> heating run of same specimen clearly indicate irreversible orientation effects induced by film extrusion process
- Exorbitant expansion and anisotropic behavior can cause problems during PV module lamination



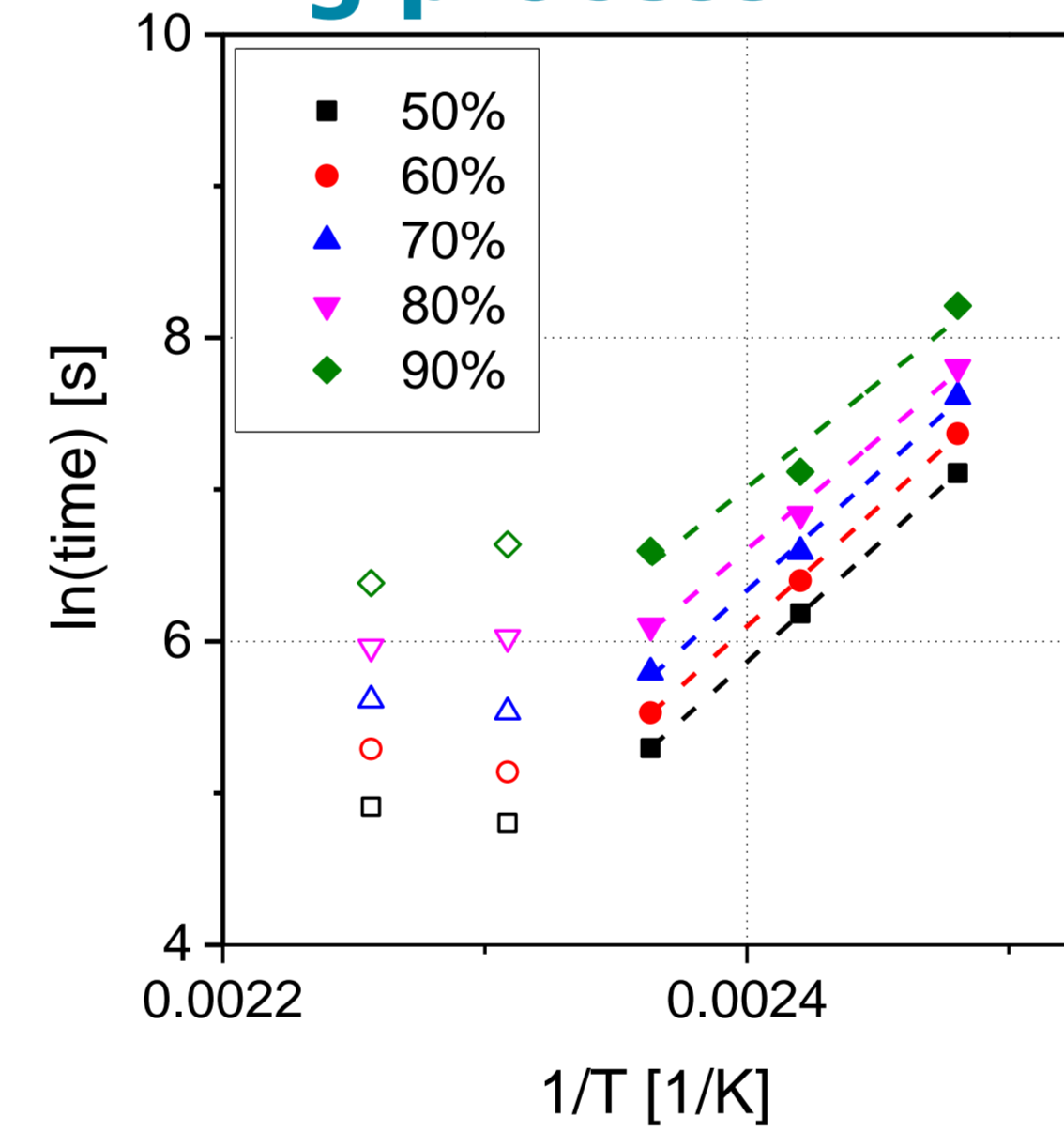
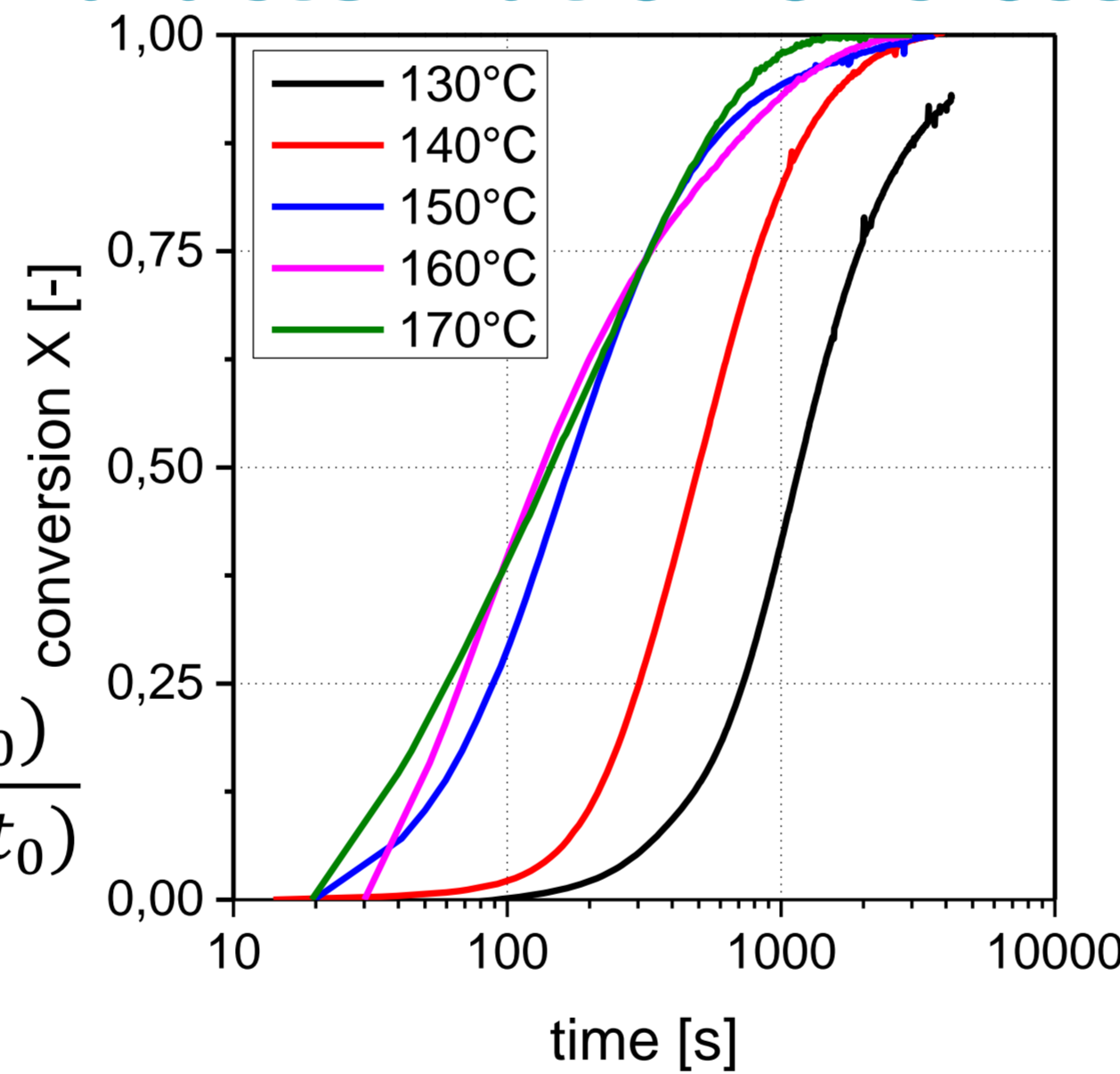
Wrinkles on PV module backsheets due to excessive anisotropic shrinkage

### Characterization of cross-linking process



➔ **Scaling by calculation of conversion rate X**

$$X = \frac{G'(t) - G'(t_0)}{G'(t_{\infty}) - G'(t_0)}$$

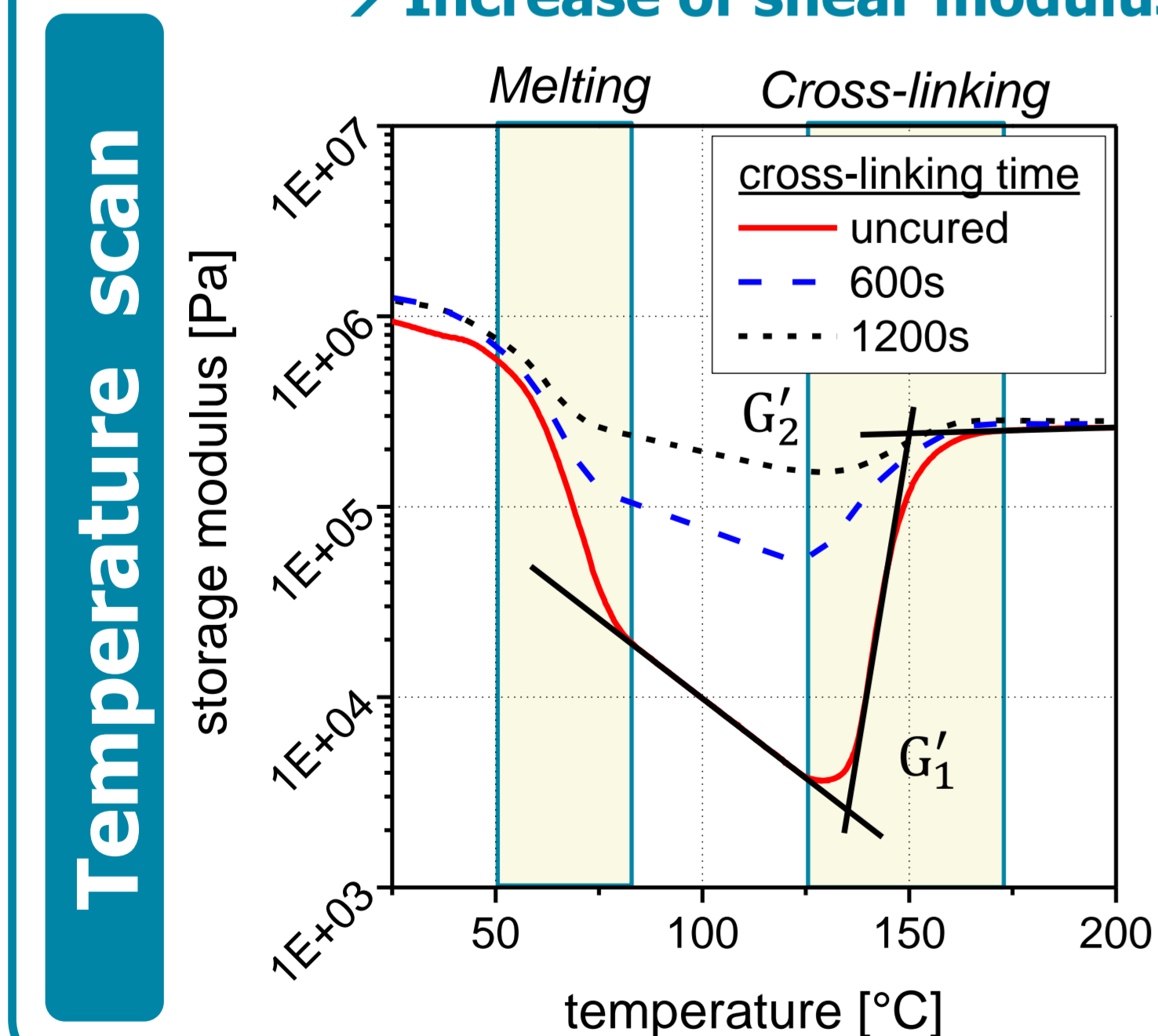


### Derivation of optimum processing times and parameters using Arrhenius plot

- ➔ Activation energy of 125±7 kJ/mol in agreement with values found in literature [2]
- ➔ Lamination temperatures >140°C are needed for full conversion
- ➔ No further acceleration of cross-linking reaction by temperatures >150°C

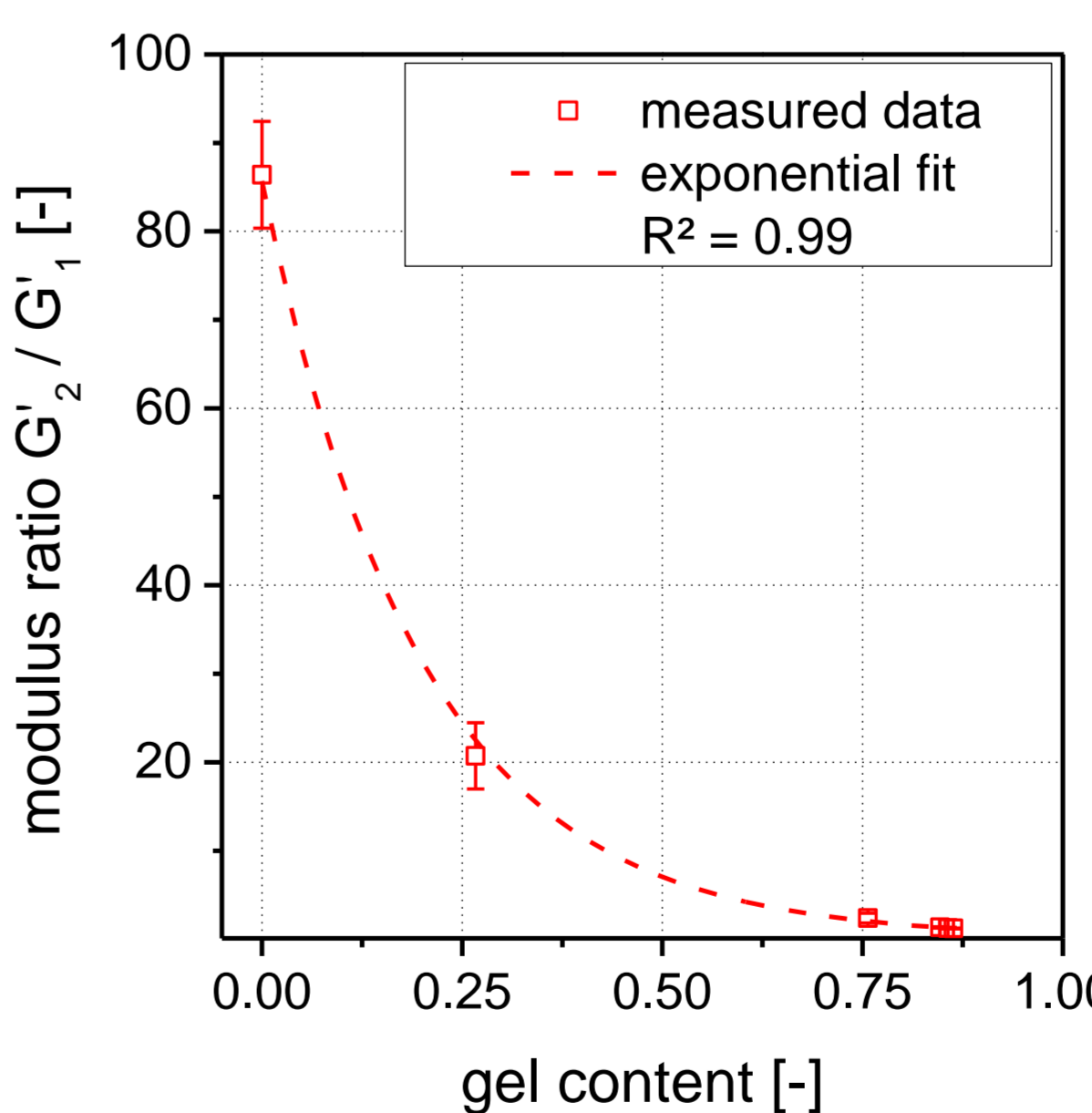
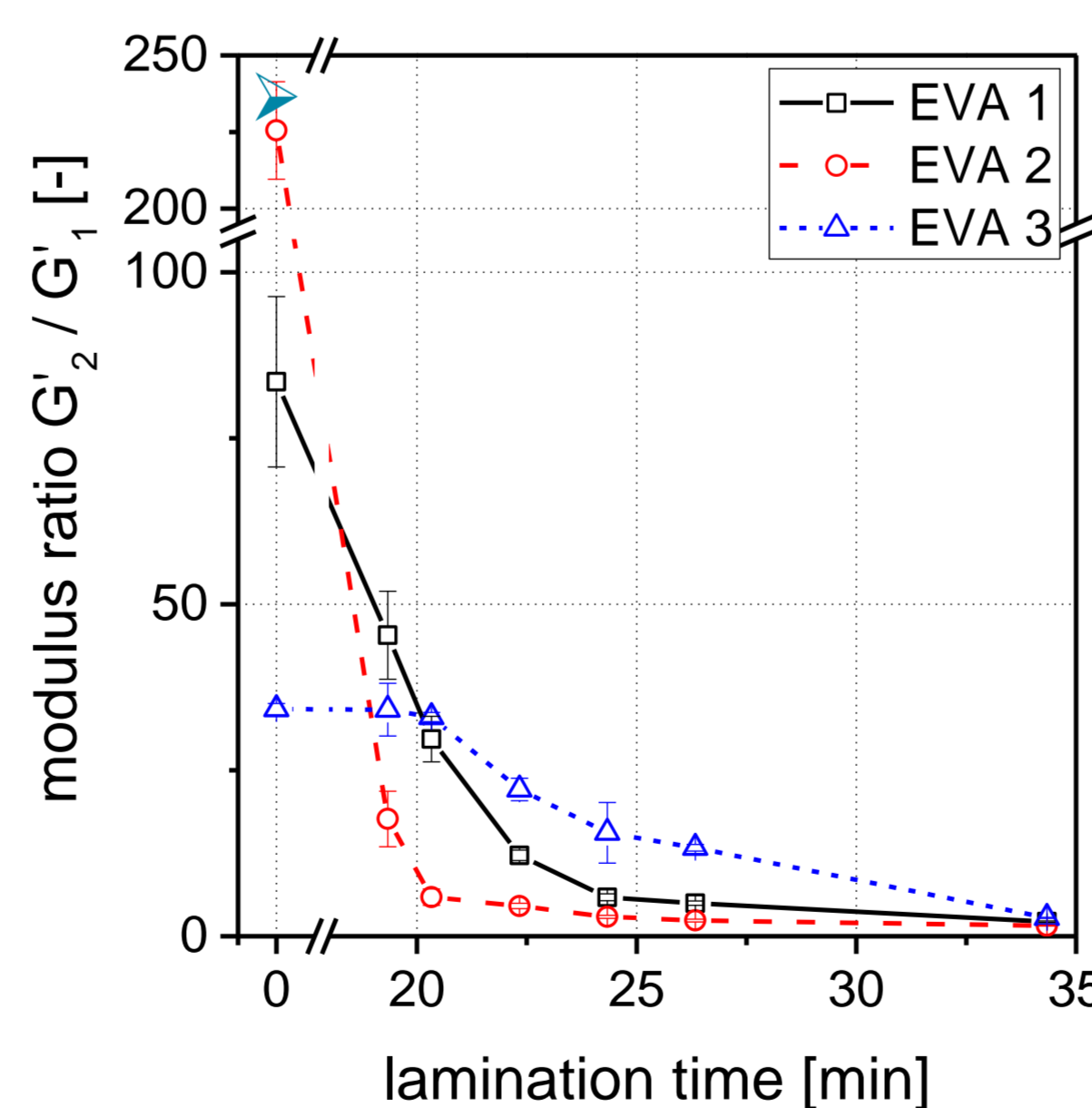
#### Please note:

Lamination temperature ≠ temperature of EVA layer



➔ **Definition of an indicator for degree of cross-linking:**

$$G'_2/G'_1$$



### Determination of degree of cross-linking

- ➔ Self referencing indicator  $G'_2/G'_1$ 
  - High reproducibility
  - Converges asymptotically to 1
- ➔ Different curing kinetics for different materials
- ➔ Lamination temperature of 146°C not sufficient for EVA 3
- ➔ Excellent correlation with gel content from Soxhlet extraction [3]

## Conclusion

- **TMA in tensile mode is a powerful tool for quality control of solar cell encapsulation materials, which allows determination of processing related effects on polymer morphology** → **Prevention of failures related to excessive anisotropic thermal expansion**
- **DMA in shear mode enables investigation of curing kinetics of solar cell encapsulation films** → **Derivation of material related process parameter optimization potentials of the PV module lamination process**
  - Determination of degree of cross-linking
  - Derivation of optimum processing temperature ranges and minimum cross-linking times

## References

[1] Ehrenstein, G.W. et al. (1998). „Praxis der thermischen Analyse von Kunststoffen“, Carl Hanser Verlag, München Wien.  
 [2] Schulze, S., *Charakterisierung polymerer Zwischenschichten in Verbundglas-Solarmodulen*. PhD thesis at Zentrum für Ingenieurwissenschaften der Martin-Luther-Universität Halle-Wittenberg, 2011  
 [3] Ch. Hirschl, M. Biebl-Rydlo, M. DeBiasio, W. Mühleisen, L. Neumaier, W. Scherf, G. Oreski, G. Eder, B. Chernev, W. Schwab and M. Kraft, *Solar Energy Materials & Solar Cells*116 (2013) 203–218